

Title (en)  
METHOD FOR PRODUCING HEAVY HIGHLY ADHESIVE PROTECTIVE COATINGS ON VALVE-METAL PARTS BY MICRO-ARC OXIDATION

Title (de)  
VERFAHREN ZUR HERSTELLUNG VON SCHWEREN HOCHADHÄSIVEN SCHUTZBESCHICHTUNGEN AUF VENTILMETALLTEILEN DURCH MIKROLICHTBOGENOXIDATION

Title (fr)  
PROCEDE DE FORMATION DE REVETEMENTS DE PROTECTION A DEGRE D'ADHERENCE ELEVE SUR DES PIECES FAITES DE METAUX UTILISES DANS DES VANNES EN MODE D'OXYDATION PAR ONDES MILLIMETRIQUES

Publication  
**EP 1715083 A4 20080521 (EN)**

Application  
**EP 04748894 A 20040112**

Priority  
RU 2004000005 W 20040112

Abstract (en)  
[origin: EP1715083A1] The invention relates to electrochemistry, in particular to anodizing parts made of valve metals such as aluminium, titanium, tantalum etc and alloys thereof and can be used for producing solid heat-resistant and wear-resistant coatings for mechanical engineering. A method consists in placing a part in an electrolyte on a current-conductive holder coated with an insulating material, producing a working voltage between said part and electrolyte and raising the voltage until a micro-arc discharge is originated on the part surface. The holder of the part is externally coated with an electroinsulating material at the air-electrolyte interface. The technical result of the invention is to produce by micro-arc oxidation heavy protective coatings which exhibit a high-hardness, have a low friction factor and a high adhesion to a base material on the parts made of the valve metals or alloys thereof.

IPC 8 full level  
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